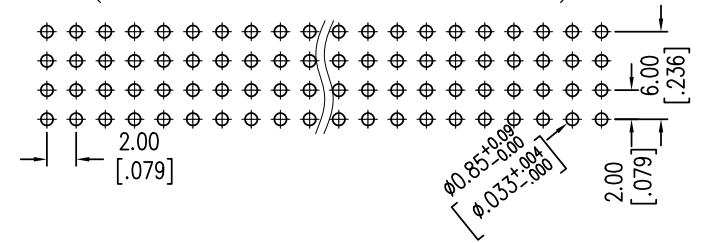


HSF

NOTES:
 Current Rating: 2.0AMP
 Contact Resistance: 20mΩ Max
 Withstand Voltage: 500V AC/DC
 Insulation Resistance: 1000MΩ Min
 Operation Temperature: -40℃ to +105℃
 Contact Material: Copper Alloy
 Contact Plating: Au Over Ni
 Insulator Material: High Temperature Thermoplastic(UL94V-0)

Recommended P.C.B Layout(Top Side)
 (PCB BOARD TOLERANCE±0.05)

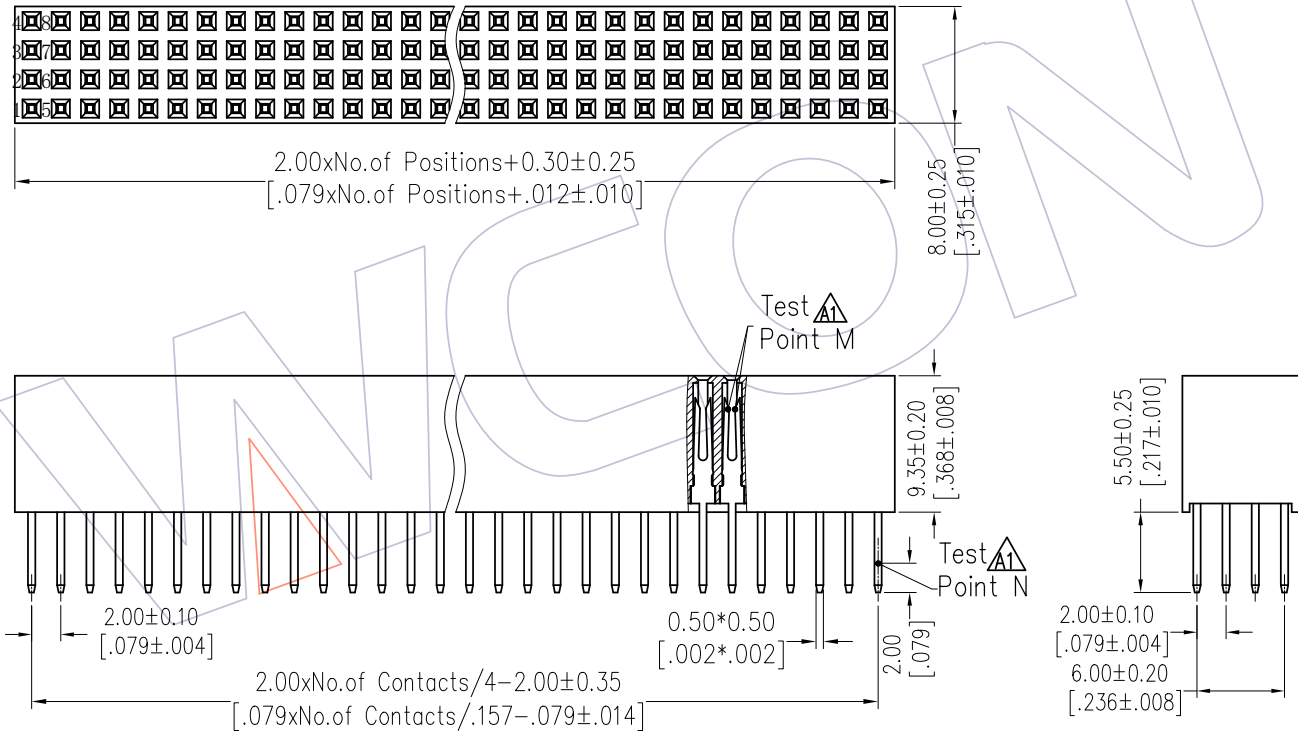


Ordering Information

2293 - 4 XX S XX CYN X 7

No. of Pins per ROW: 02-40PIN
 Contact Plating: G1=Fully 3μ"Gold, G3=Fully 10μ"Gold, G4=Fully 15μ"Gold, H3=Mating 10u"Gold Tail 3u"Gold, H4=Mating 15u"Gold Tail 3u"Gold
 Insulator: C=PA9T
 Packing: T=Tube

Contact Plating	Gold Test Point M	Gold Test Point N
G1	3U"	3U"
G3	10U"	10U"
G4	15U"	15U"
H3	10U"	3U"
H4	15U"	3U"



Item	Pitch	Mating
Standard	2.00	1215/1220
Alternate		

REV	DATE	MODIFICATION DESCRIPTION	CHANGE	OPERATION	DRAW	DATE	SCALE	FIT	PART NO.
A1	2019/12/30	Modify drawing		x.x ±0.40	Surong Xu	2019/12/30	UNIT mm		2293-4XXSXXXYNX7
A0	2017/05/24	NEW		x.xx ±0.25	CHECK	DATE	SIZE A4		TITLE: 2.00*2.00mm PC104 Plus FOUR ROW 180°DIP H=9.35 DIP=5.50
				x.xxx ±0.15	APPROVE	DATE	SHEET 1/1		Customer NO.
				Angle ± 3°			PROJ.		
				DIM TOL					

WCON

Http: www.wcon.com

WCON-Dongguan Tel: +86 769 85358920 Fax: +86 769 85358915 E-mail: sales@wcon.com
 WCON-Kunshan Tel: +86 512 57468408 Fax: +86 512 57468468 E-mail: salesks@wcon.com